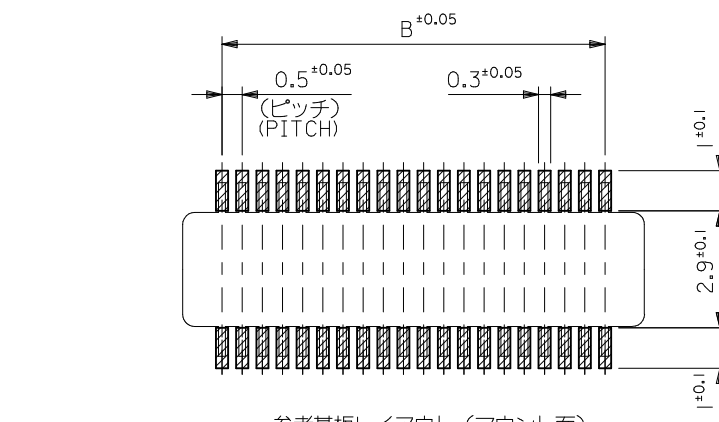
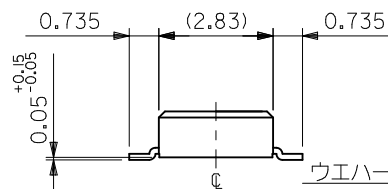
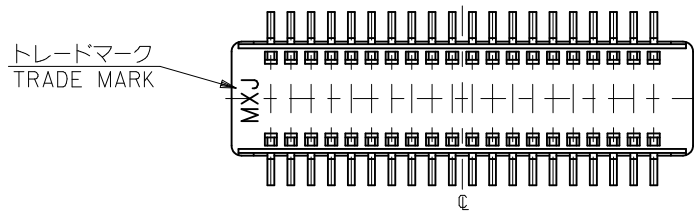
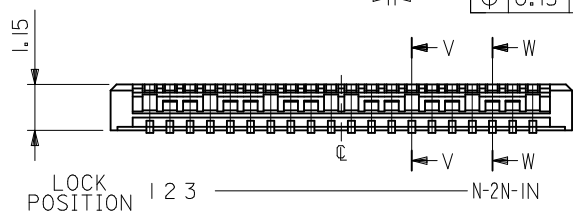
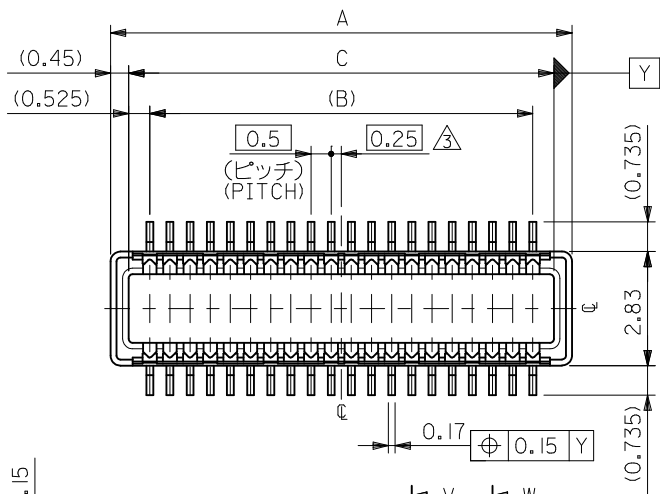
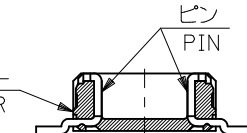
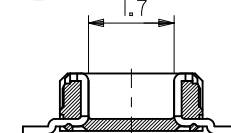




参考基板レイアウト (マウント面)
P.C. BOARD PATTERN
DIMENSION (REF.)
(MOUNTING AREA)



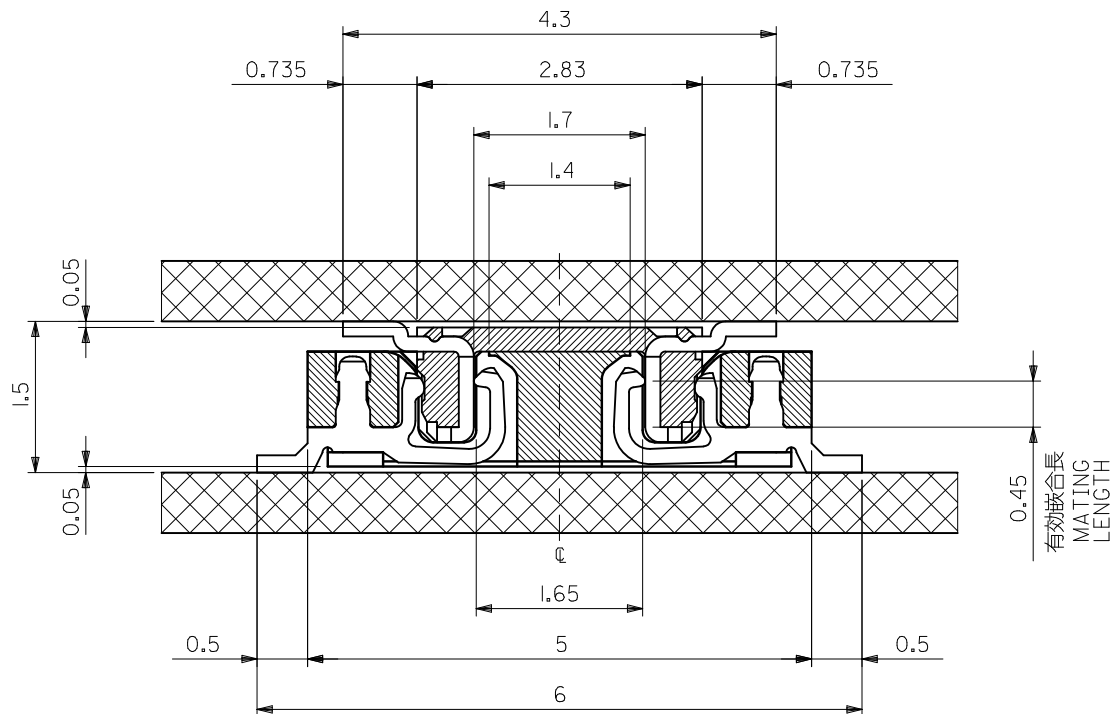
SECT.W-W(LOCK PART)



SECT.V-V(W/O LOCK PART)

NON	20.55	19.5	21.45	55560-0801	80
10,21	15.55	14.5	16.45	-0601	60
2,4,8,10,16,18,22,24	13.05	12.0	13.95	-0501	50
2,3,5,6,8,9,12,13,15,16,18,19	10.55	9.5	11.45	-0401	40
2,3,4,5,7,8,9,10,11,13,14,15,16	9.05	8.0	9.95	-0341	34
ALL	8.05	7.0	8.95	-0301	30
	6.55	5.5	7.45	-0241	24
	6.05	5.0	6.95	-0221	22
	5.55	4.5	6.45	-0201	20
	4.55	3.5	5.45	55560-0161	16
LOCK POSITION	C	B	A	MATERIAL NO.	極数 CIRCUIT

REVISED EC NO: J2012-0135 DRWN:YON002 CHKD:TASAKAWA APPR:MSASAO 2011/07/01 2011/07/01 2011/07/19	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
		10 UNDER	± 0.20	DRAWN BY SAIHARA	DATE 2003/03/31	TITLE 0.5 B-TO-B CONN PLUG ASSY (HGT=1.5)				
		10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2003/03/31					
		30 OVER	± 0.30	APPROVED BY MSASAO	DATE 2003/03/31	MOLEX INCORPORATED				
		ANGULAR ±3 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SD-55560-006		1 OF 2		
		K		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



嵌合断面図 (参考)
MATED DRAWING (REF.)

注記 NOTES:

1. 使用材料 MATERIAL
ウェハー : 液晶ポリマー ガラス充填 ,UL94V-0 (黒)
WAFER : LIQUID CRYSTAL POLYMER (GLASS FILLED), UL94V-0 (COLOR:BLACK)
ピン : 黄銅 (t=0.15)
PIN : BRASS (t=0.15)
2. メッキ仕様 PLATING
金メッキ 0.25 MICROMETER MINIMUM (コンタクト部)
GOLD 0.25 MICROMETER MINIMUM (CONTACT AREA).
金メッキ 0.4 MICROMETER MAXIMUM (テール部)
GOLD 0.4 MICROMETER MAXIMUM (TAIL AREA).
下地メッキ : ニッケルメッキ 1.5 MICROMETER MINIMUM
UNDER PLATING : NICKEL 1.5 MICROMETER MINIMUM.
3. (全極数/2) = 偶数の場合に適用。
APPLY FOR (CIRCUIT/2)=EVEN.
4. 嵌合相手 : 54722 シリーズ, 54037 シリーズ
MATE WITH : 54722 SERIES, 54037 SERIES.
5. テール平坦度は、0.1 MAXIMUM
TAIL COPLANARITY TO BE 0.1 MAXIMUM.

REVISED EC NO: J2012-0135 DRWN: YON002 CHKD: TASAKAWA APPR: MSASAO 2011/07/01 2011/07/01 2011/07/29	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
		10 UNDER	± 0.20	DRAWN BY SAIHARA	DATE 2000/10/05	TITLE 0.5 B-TO-B CONN PLUG ASSY (HGT=1.5)			
		10 OVER 30 UNDER	± 0.25	CHECKED BY MSASAO	DATE 2003/03/31				
		30 OVER	± 0.30	APPROVED BY MSASAO	DATE 2003/03/31	 MOLEX INCORPORATED			
		ANGULAR ±3 °		MATERIAL NO. SEE SHEET 1					
	K	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			

DWG. NO. SD-55560-008

E

D

C

B

DO NOT SCALE DRAWING

8 7 6 5 4 3 2 1

F

E

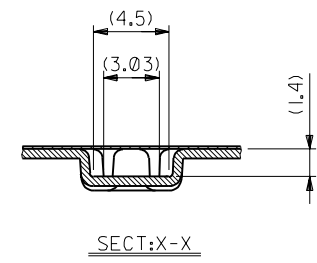
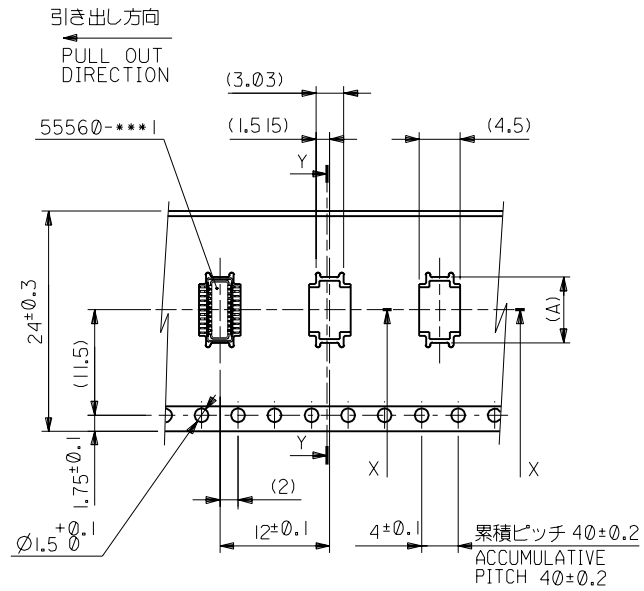
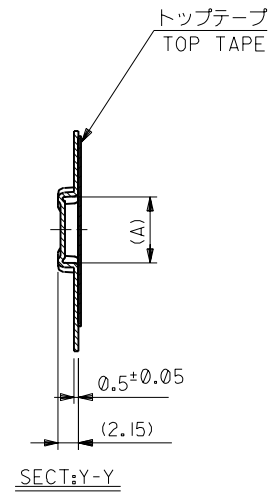
D

C

B

A

55560008.S03



24mm幅キャリアテープ
24mm WIDTH CARRIER TAPE

24		25.5		7.15		55560-0228		22			
キャリアテープ幅 CARRIER TAPE WIDTH				B		(A)		MATERIAL NO.		極数 CIRCUIT	
MODEL NO.				55560-***8				DIMENSIONS:		SHT REV	
SCALE --		DESIGN UNITS □mm □INCH		◎ 20° 20° 20° ANGLE PROJECTION		□mm □INCH □mm ONLY		☒mm ONLY		REVISE ON CAD ONLY	
DRAWN BY & DATE S.AIHARA '00/11/28				TITLE: 0.5 B-To-B Conn PLUG Assy (Hg+=1.5) Embstp Pkg							
CHECKED BY & DATE T.IITO '01/01/30											
APPROVED BY & DATE M.FUKUSHIMA '01/01/30				MOLEX INCORPORATED							
CAD FILENAME 55560008.S03											
MATERIAL NO. SEE CHART				DRAWING NO. SD-55560-008				SHEET NO. 3 OF 3			
2865 DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.										SIZE B	

DESIGN NO. JC2001-0604	DESIGN NO. JC2001-0402	REV
DRWN: R.SHIINA '01/01/30	DRWN: S.AIHARA '00/11/28	
CHK: T.IITO	CHK: T.IITO	
APPR: M.FUKUSHIMA	APPR: M.FUKUSHIMA	
REVISED	PROPOSED	
DESIGN NO. JC2001-0604	DESIGN NO. JC2001-0402	
DRWN: R.SHIINA '01/01/30	DRWN: S.AIHARA '00/11/28	
CHK: T.IITO	CHK: T.IITO	
APPR: M.FUKUSHIMA	APPR: M.FUKUSHIMA	

8 7 6 5 4 3 2 1